Contact Name  Title - Contact  Product-Env-Stewards Authorized Representative*  Product-Env-Stewards  Product Enviro Compliance  Title - Representative  Phone - Contact*  Phone - Contact*  Product-Env-Stewards@onsemi.com  Phone - Representative*  Email - Representative*  Email - Representative*  Product-Env-Stewards  Product-Env-Stewards@onsemi.com  Requester Item Number  Mfr Item Number  Mfr Item Name  Effective Date  Version  Manufacturing Site  Weight*  UOM  U	IPC ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
Company name* Company unique ID  Unique ID Authority  Response Date*  2024-04-30  Contact Name  Title - Contact  Phone - Contact*  Phone - Contact*  Product-Env-Stewards  Produ	752-21.1											als and Mf	g Informati	ion	
Insemi ontact Name Orduct Env-Stewards Orduct Enviro Compliance Orduct-Env-Stewards Orduct Enviro Compliance Orduct-Env-Stewards Orduct-Env-Stewar	upplier Informa	ntion													
Title - Contact Name Product Env-Stewards Product Env-Stewards Product Enviro Compliance Product Env-Stewards	Company name*			Company unique ID			J	Unique ID Authority				Response Date*			
Product Env-Stewards uthorized Representative* Title - Representative Product Enviro Compliance NA Product Env-Stewards Product Env-Stewards Product Enviro Compliance NA Product Env-Stewards Product Env-Stew	nsemi											2024-04-30			
Authorized Representative* Product-Env-Stewards Product Enviro Compliance Requester Item Number Mfr Item Number Mfr Item Number Mfr Item Name    Effective Date   Version   Manufacturing Site   Weight*   UOM   U	ontact Name			Title - Contact			I	Phone - Contact*				Email - Contact*			
Product-Env-Stewards  Requester Item Number  Mfr Item Number  Mfr Item Number  Mfr Item Name  Effective Date  Version  Manufacturing Site  Weight*  UOM  U  2SK3557-7-TB-E  NCH J-FET  2024-04-30  CNG  11.89  mg  E  Manufacturing Process Information  Terminal Plating / Grid Array Material  Terminal Base Alloy  Terminal Plating / Grid Array Material  Terminal Base Alloy  Terminal Base Al	Product-Env-Stewar	ds		Product Enviro Compliance			]	NA				Product-Env-Stewards@onsemi.com			
Requester Item Number	uthorized Represen	tative*		Title - Representative			I	Phone - Representative*			Email - Representative*				
2SK3557-7-TB-E   NCH J-FET   2024-04-30   CNG   11.89   mg   Example 2	Product-Env-Stewar	ds		Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com			
Anufacturing Proccess Information  Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycles contains Bi  CU Alloy 1 260 C 30 seconds 3	Requester	Requester Item Number Mfr Iter		a Number Mfr Item Name				Effective Date	Version	N	Manufacturing Site		Veight*	UOM	Unit Type
Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycles contains Bi  CU Alloy 1 260 C 30 seconds 3			2SK3557-	-7-TB-E	NCH J-FET			2024-04-30		(	CNG	1	1.89	mg	Each
contains Bi CU Alloy 1 260 C 30 seconds 3 comments				. 1D	A 11	GTD 020 MGI	D. C	D 1 D	D 1 7		M Ti D . 1	T.	N. 1	SD G G	1
omments				,		STD-020 MSL	Rating			Т '				er of Reflow Cyc	les
		1	C	U Alloy	1			200		IC	30	second	IS   3		
vei 1 - maximum time at peak temperature during soldering is 10-30 seconds				1. 1. 1. 10.1	20										
or more information regarding material composition please refer to page 3															

RoHS Material Composition Declaration			Declaration Type *	Detail	ed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its uppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In t										
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the					

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.11	mg	Supplier	Silicon (Si)	7440-21-3		0.11	mg
Lead Frame	2.79 mg		Supplier	Silver (Ag)	7440-22-4		0.043	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0025	mg
			Supplier	Manganese (Mn)	7439-96-5		0.0209	mg
			Supplier	Silicon (Si)	7440-21-3		0.0078	mg
			В	Nickel (Ni)	7440-02-0		1.0917	mg
			Supplier	Iron (Fe)	7439-89-6		1.5077	mg
			Supplier	Copper (Cu)	7440-50-8		0.1161	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0003	mg
Mold Compound-Black	8.75		В	Brominated Bisphenol A Diglycidyl Ether	40039-93-8		0.2188	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		0.1312	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0875	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		1.3125	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.875	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		6.125	mg
Plating	0.22	mg	В	Bismuth (Bi)	7440-69-9		0.0013	mg
			Supplier	Tin (Sn)	7440-31-5		0.2187	mg
Wire Bond - Au	0.02	mg	Supplier	Gold (Au)	7440-57-5		0.02	mg